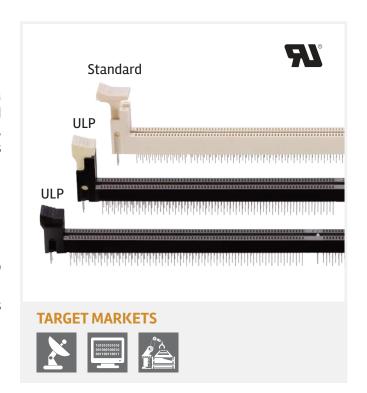
DDR4 ULTRA LOW PROFILE MEMORY MODULE SOCKETS



SPECIALLY DESIGNED SOCKETS FOR LOW PROFILE SYSTEM

DDR4 Ultra Low Profile (ULP) vertical DIMM sockets provide 288 contacts on 0.85mm pitch and facilitate convenient memory expansion in servers, workstations, desktop PCs, and embedded applications in communications and industrial equipment.

- Ultra low module seating height of 1.1mm
- Lowest connector height of 13.1mm
- Reduced overall profile of the connector
- Compatible with standard DIMM module to help optimize airflow
- Low resistance contacts (registered DIMM) reduces power consumption in hardware



FEATURES

- Ultra low module seating height of 1.1mm
- Low connector height of 13.1mm and 19.3mm
- Profiled contact design
- Multi-tail length
- Compact connector footprint of 6.5mm (W) by 152mm (L)
- RoHS compliant, low halogen and Lead-Free

BENEFITS

- Allows low profile server design
- Supports standard DIMM module to optimize airflow
- Reduces terminal and housing stress during module insertion
- Supports 1.6mm or 2.4mm thick motherboards
- Reduces valuable board space and cost
- Meets environmental requirements

DDR4 ULTRA LOW PROFILE MEMORY MODULE SOCKETS

TECHNICAL INFORMATION

MATERIAL

- Contact : Copper Alloy
- Contact Finish:
 - Contact Area: 15μin. , 20μin. or 30μin. Gold, 30μin. GXT™ or Gold Flash over Nickel
 - Termination Area: Tin over Nickel
- Forklock: Copper Alloy
- Housing & Ejector: High Temperature Thermoplastic, UL94V-0

MECHANICAL PERFORMANCE

• Durability: 25 mating cycles

APPROVALS AND CERTIFICATIONS

■ UL E66906

PACKAGING

Tray

ELECTRICAL PERFORMANCE

- Contact Resistance: \leq 10m Ω initial, \leq 10m Ω increase after environmental test
- Current Rating: 0.75A/contact (De-rated) with
 ≤ 30°C temperature rise above ambient

SPECIFICATIONS

- Product Specification: GS-12-1092
- Packaging Specification: GS-14-2267
- Application Specification: GS-20-0353
- JEDEC
- Module Outline: MO-309
- Socket Outline: SO-016 (PTH Solder)

TARGET MARKETS/APPLICATIONS



Switches Router Wireless Infrastructure



Server Storage System Supercomputer Workstation Desktop PC



Embedded System

PART NUMBERS

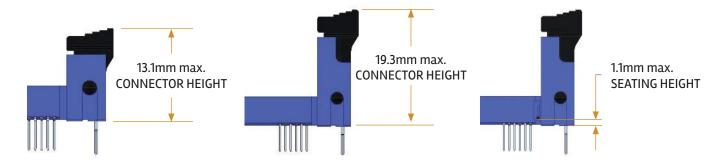
Description	Termination Option	Color	Part Number
DDR4 Ultra Low Profile Plated Through Hole (ULP PTH)	Solder- termination with forklocks	Housing: Black, Natural, Blue Ejectors: Black, Natural, Blue	10129206

DDR4 ULTRA LOW PROFILE MEMORY MODULE SOCKETS

CONNECTOR DIMENSIONS

DDR4 ULP offers lower seating and connector height. Compatible with standard DIMM module, the overall height can be reduced significantly from 21.3mm to 13.1mm. DDR4 ULP allows customer to improve on the airflow and addresses the need for low profile server design, in applications such as 1U server, micro server, industrial/communication applications.

DDR4 ULTRA LOW PROFILE



DDR4 STANDARD

